onsemi

Dual PNP Bias Resistor Transistors

R1 = 2.2 k Ω , **R2 = 47 k** Ω

PNP Transistors with Monolithic Bias Resistor Network

MUN5135DW1, NSBA123JDXV6, NSBA123JDP6

This series of digital transistors is designed to replace a single device and its external resistor bias network. The Bias Resistor Transistor (BRT) contains a single transistor with a monolithic bias network consisting of two resistors; a series base resistor and a base–emitter resistor. The BRT eliminates these individual components by integrating them into a single device. The use of a BRT can reduce both system cost and board space.

Features

- Simplifies Circuit Design
- Reduces Board Space
- Reduces Component Count
- NSV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

MAXIMUM RATINGS

(T_A = 25°C, common for Q1 and Q2, unless otherwise noted)

| Rating | Symbol | Max | Unit |
|--------------------------------|----------------------|-----|------|
| Collector-Base Voltage | V _{CBO} | 50 | Vdc |
| Collector-Emitter Voltage | V _{CEO} | 50 | Vdc |
| Collector Current – Continuous | ۱ _C | 100 | mAdc |
| Input Forward Voltage | V _{IN(fwd)} | 12 | Vdc |
| Input Reverse Voltage | V _{IN(rev)} | 5 | Vdc |

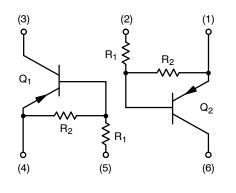
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

ORDERING INFORMATION

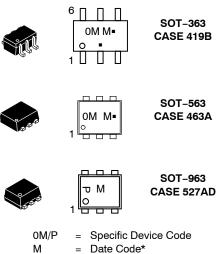
| Device | Package | Shipping [†] |
|------------------------------------|---------|-----------------------|
| MUN5135DW1T1G, NSVMUN5135DW1T1G | SOT-363 | 3,000 / Tape & Reel |
| NSBA123JDXV6T1G | SOT-563 | 4,000 / Tape & Reel |
| NSBA123JDXV6T5G | SOT-563 | 8,000 / Tape & Reel |
| NSBA123JDP6T5G | SOT-963 | 8,000 / Tape & Reel |

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

PIN CONNECTIONS



MARKING DIAGRAMS



= Pb-Free Package

(Note: Microdot may be in either location)

*Date Code orientation may vary depending upon manufacturing location.

MUN5135DW1, NSBA123JDXV6, NSBA123JDP6

THERMAL CHARACTERISTICS

| | Characteristic | Symbol | Max | Unit |
|--|------------------------------|-----------------------------------|--------------------------|-------------|
| MUN5135DW1 (SOT-363) One | Junction Heated | | | |
| Total Device Dissipation $T_A = 25^{\circ}C$ (Note 1) (Note 2) Derate above 25^{C} (Note 2) | Note 1) | PD | 187 256 1.5 2.0 | m₩ mW/°C |
| | Note 1) Note 2) | R _{θJA} | 670 490 | °C/W |
| MUN5135DW1 (SOT-363) Both | Junction Heated (Note 3) | | | |
| $\begin{array}{l} \mbox{Total Device Dissipation} \\ T_A = 25^\circ C & (Note 1) \\ & (Note 2) \\ \mbox{Derate above } 25^\circ C \\ & (Note 2) \end{array}$ | Note 1) | PD | 250 385 2.0 3.0 | mW mW/°C |
| | Note 1) Note 2) | $R_{	heta JA}$ | 493 325 | °C/W |
| Thermal Resistance, Junction to Lead (Note 2) | Note 1) | R _{θJL} | 188 208 | °C/W |
| Junction and Storage Temperat | ure Range | T _J , T _{stg} | –55 to +150 | °C |
| NSBA123JDXV6 (SOT-563) OI | ne Junction Heated | | | |
| Total Device Dissipation $T_A = 25^{\circ}C$ (Note 1) Derate above $25^{\circ}C$ | Note 1) | PD | 357 2.9 | mW mW/°C |
| Thermal Resistance, Junction to Ambient | Note 1) | R _{θJA} | 350 | °C/W |
| NSBA123JDXV6 (SOT-563) Bo | oth Junction Heated (Note 3) | | • | |
| Total Device Dissipation $T_A = 25^{\circ}C$ (Note 1)Derate above $25^{\circ}C$ | Note 1) | P _D | 500 4.0 | mW mW/°C |
| Thermal Resistance, Junction to Ambient | Note 1) | $R_{	heta JA}$ | 250 | °C/W |
| Junction and Storage Temperat | ure Range | T _J , T _{stg} | –55 to +150 | °C |
| NSBA123JDP6 (SOT-963) One | Junction Heated | | | |
| Total Device Dissipation $T_A = 25^{\circ}C$ (Note 4) (Note 5) Derate above $25^{\circ}C$ (Note 5) | Note 4) | PD | 231 269 1.9 2.2 | mW mW/°C |
| | Note 4) Note 5) | $R_{	heta JA}$ | 540 464 | °C/W |
| NSBA123JDP6 (SOT-963) Bot | h Junction Heated (Note 3) | | | |
| Total Device Dissipation $T_A = 25^{\circ}C$ (Note 4) (Note 5) Derate above $25^{\circ}C$ (Note 5) | Note 4) | PD | 339 408 2.7 3.3 | mW mW/°C |
| | Note 4) Note 5) | R _{θJA} | 369 306 | °C/W |
| Junction and Storage Temperat | _ | T _J , T _{stg} | -55 to +150 | °C |

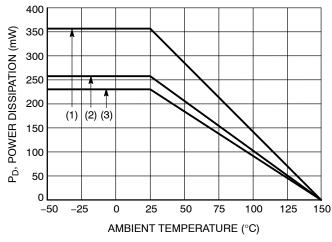
FR-4 @ Minimum Pad.
 FR-4 @ 1.0 x 1.0 Inch Pad.
 Both junction heated values assume total power is sum of two equally powered channels.
 FR-4 @ 100 mm², 1 oz. copper traces, still air.
 FR-4 @ 500 mm², 1 oz. copper traces, still air.

MUN5135DW1, NSBA123JDXV6, NSBA123JDP6

ELECTRICAL CHARACTERISTICS ($T_A = 25^{\circ}C$, common for Q_1 and Q_2 , unless otherwise noted)

| Characteristic | Symbol | Min | Тур | Max | Unit |
|--|--------------------------------|-------|-------|-------|------|
| OFF CHARACTERISTICS | | | | | |
| Collector-Base Cutoff Current (V _{CB} = 50 V, I _E = 0) | I _{CBO} | _ | _ | 100 | nAdc |
| Collector–Emitter Cutoff Current $(V_{CE} = 50 \text{ V}, I_B = 0)$ | I _{CEO} | _ | _ | 500 | nAdc |
| Emitter-Base Cutoff Current $(V_{EB} = 6.0 \text{ V}, I_C = 0)$ | I _{EBO} | - | _ | 0.2 | mAdc |
| Collector-Base Breakdown Voltage ($I_C = 10 \ \mu A, I_E = 0$) | V _(BR) CBO | 50 | _ | _ | Vdc |
| Collector–Emitter Breakdown Voltage (Note 6) $(I_C = 2.0 \text{ mA}, I_B = 0)$ | V _(BR) CEO | 50 | _ | - | Vdc |
| ON CHARACTERISTICS | | | | | |
| DC Current Gain (Note 6) ($I_C = 5.0 \text{ mA}, V_{CE} = 10 \text{ V}$) | h _{FE} | 80 | 140 | _ | |
| Collector–Emitter Saturation Voltage (Note 6) $(I_C = 10 \text{ mA}, I_B = 0.3 \text{ mA})$ | V _{CE(sat)} | - | _ | 0.25 | Vdc |
| Input Voltage (off) (V _{CE} = 5.0 V, I _C = 100 μA) | V _{i(off)} | - | 0.6 | - | Vdc |
| Input Voltage (on) (V_{CE} = 0.2 V, I _C = 5.0 mA) | V _{i(on)} | - | 0.8 | - | Vdc |
| Output Voltage (on) (V _{CC} = 5.0 V, V _B = 2.5 V, R _L = 1.0 k Ω) | V _{OL} | - | _ | 0.2 | Vdc |
| Output Voltage (off) (V _{CC} = 5.0 V, V _B = 0.5 V, R _L = 1.0 k Ω) | V _{OH} | 4.9 | - | - | Vdc |
| Input Resistor | R1 | 1.5 | 2.2 | 2.9 | kΩ |
| Resistor Ratio | R ₁ /R ₂ | 0.038 | 0.047 | 0.056 | |

6. Pulsed Condition: Pulse Width = 300 msec, Duty Cycle \leq 2%.



(1) SOT-363; 1.0 x 1.0 inch Pad
(2) SOT-563; Minimum Pad
(3) SOT-963; 100 mm², 1 oz. copper trace

Figure 1. Derating Curve

TYPICAL CHARACTERISTICS MUN5135DW1, NSBA123JDXV6

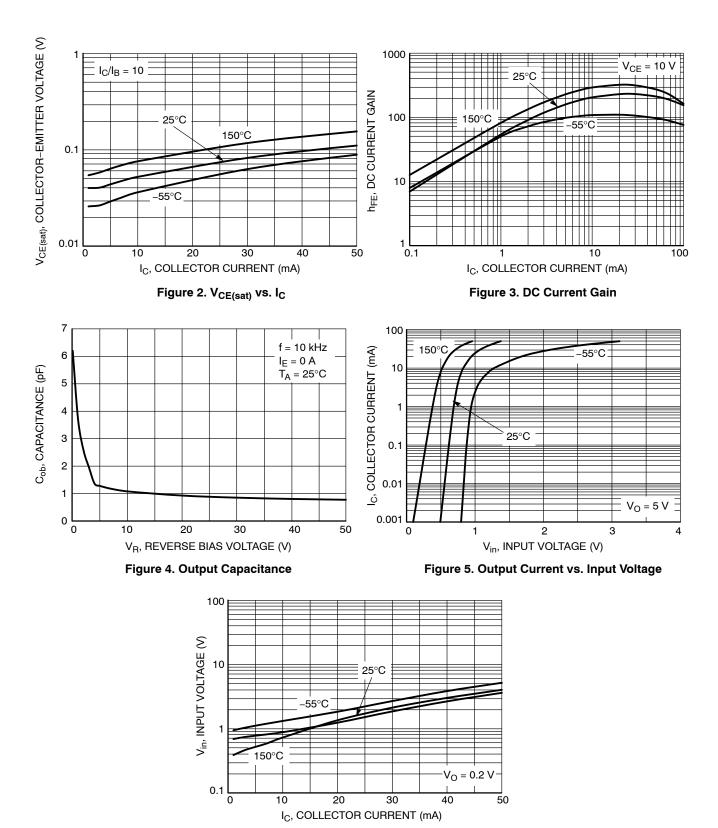
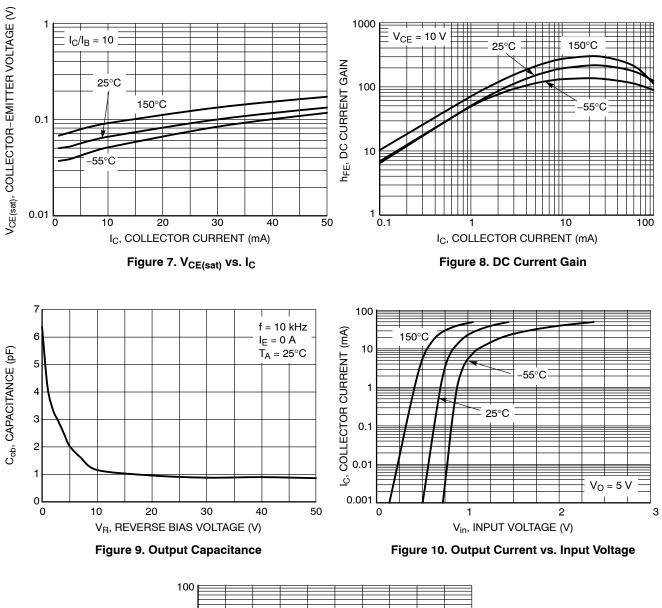
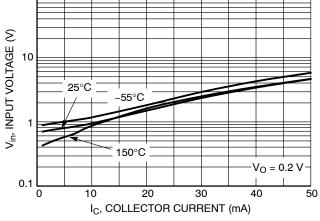


Figure 6. Input Voltage vs. Output Current

MUN5135DW1, NSBA123JDXV6, NSBA123JDP6

TYPICAL CHARACTERISTICS NSBA123JDP6



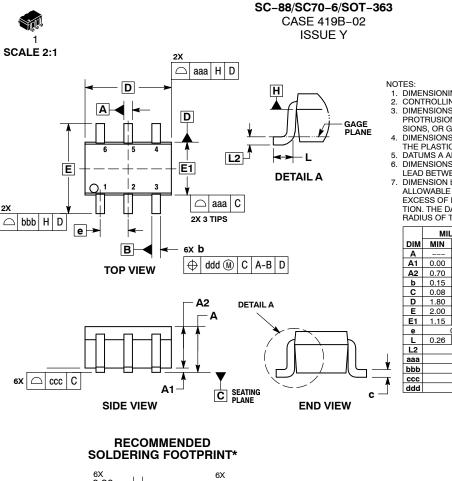




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DATE 11 DEC 2012



6X 0.30 0.66 2 50 0.65 PITCH DIMENSIONS: MILLIMETERS

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
 CONTROLLING DIMENSION MILLIMETERS
- CONTROLLING DIMENSION: MILLIMETERS. DIMENSIONS D AND E1 DO NOT INCLUDE MOLD FLASH,
- PROTRUSIONS, OR GATE BURRS. MOLD FLASH, PROTRU-SIONS, OR GATE BURRS SHALL NOT EXCEED 0.20 PER END. SIONS, OH GATE BUHHS SHALL NOT EXCEED 0.20 PEH END. DIMENSIONS D AND ET AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY AND DATUM H. DATUMS A AND B ARE DETERMINED AT DATUM H. DIMENSIONS 5 AND 6 APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN 0.08 AND 0.15 FROM THE TIP.
- DIMENSION b DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 TOTAL IN EXCESS OF DIMENSION 6 AT MAXIMUM MATERIAL CONDI-TION. THE DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OF THE FOOT.

| | MILLIMETERS | | | | INCHES | 3 |
|-----|-------------|------|------|-----------|----------|-------|
| DIM | MIN | NOM | MAX | MIN | NOM | MAX |
| Α | | | 1.10 | | | 0.043 |
| A1 | 0.00 | | 0.10 | 0.000 | | 0.004 |
| A2 | 0.70 | 0.90 | 1.00 | 0.027 | 0.035 | 0.039 |
| b | 0.15 | 0.20 | 0.25 | 0.006 | 0.008 | 0.010 |
| С | 0.08 | 0.15 | 0.22 | 0.003 | 0.006 | 0.009 |
| D | 1.80 | 2.00 | 2.20 | 0.070 | 0.078 | 0.086 |
| Е | 2.00 | 2.10 | 2.20 | 0.078 | 0.082 | 0.086 |
| E1 | 1.15 | 1.25 | 1.35 | 0.045 | 0.049 | 0.053 |
| е | 0.65 BSC | | | 0.026 BSC | | |
| L | 0.26 | 0.36 | 0.46 | 0.010 | 0.014 | 0.018 |
| L2 | 0.15 BSC | | | (| 0.006 BS | SC |
| aaa | 0.15 | | | | 0.006 | |
| bbb | 0.30 | | | | 0.012 | |
| ccc | | 0.10 | | | 0.004 | |
| ddd | | 0.10 | | | 0.004 | |

GENERIC **MARKING DIAGRAM***



XXX = Specific Device Code

- М = Date Code*
- = Pb-Free Package

(Note: Microdot may be in either location)

*Date Code orientation and/or position may vary depending upon manufacturing location.

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

STYLES ON PAGE 2

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SC-88/SC70-6/SOT-363 CASE 419B-02 ISSUE Y

DATE 11 DEC 2012

| STYLE 1: PIN 1. EMITTER 2 2. BASE 2 3. COLLECTOR 1 4. EMITTER 1 5. BASE 1 6. COLLECTOR 2 | STYLE 2: CANCELLED | STYLE 3: CANCELLED | STYLE 4: PIN 1. CATHODE 2. CATHODE 3. COLLECTOR 4. EMITTER 5. BASE 6. ANODE | STYLE 5: PIN 1. ANODE 2. ANODE 3. COLLECTOR 4. EMITTER 5. BASE 6. CATHODE | STYLE 6: PIN 1. ANODE 2 2. N/C 3. CATHODE 1 4. ANODE 1 5. N/C 6. CATHODE 2 |
|--|-----------------------|--|---|---|---|
| STYLE 7: PIN 1. SOURCE 2 2. DRAIN 2 3. GATE 1 4. SOURCE 1 5. DRAIN 1 6. GATE 2 | STYLE 8: CANCELLED | STYLE 9: PIN 1. EMITTER 2 2. EMITTER 1 3. COLLECTOR 1 4. BASE 1 5. BASE 2 6. COLLECTOR 2 | STYLE 10: PIN 1. SOURCE 2 2. SOURCE 1 3. GATE 1 4. DRAIN 1 5. DRAIN 2 6. GATE 2 | STYLE 11: PIN 1. CATHODE 2 2. CATHODE 2 3. ANODE 1 4. CATHODE 1 5. CATHODE 1 6. ANODE 2 | STYLE 12: PIN 1. ANODE 2 2. ANODE 2 3. CATHODE 1 4. ANODE 1 5. ANODE 1 6. CATHODE 2 |
| STYLE 13: | STYLE 14: | STYLE 15: | STYLE 16: | STYLE 17: | STYLE 18: |
| PIN 1. ANODE | PIN 1. VREF | PIN 1. ANODE 1 | PIN 1. BASE 1 | PIN 1. BASE 1 | PIN 1. VIN1 |
| 2. N/C | 2. GND | 2. ANODE 2 | 2. EMITTER 2 | 2. EMITTER 1 | 2. VCC |
| 3. COLLECTOR | 3. GND | 3. ANODE 3 | 3. COLLECTOR 2 | 3. COLLECTOR 2 | 3. VOUT2 |
| 4. EMITTER | 4. IOUT | 4. CATHODE 3 | 4. BASE 2 | 4. BASE 2 | 4. VIN2 |
| 5. BASE | 5. VEN | 5. CATHODE 2 | 5. EMITTER 1 | 5. EMITTER 2 | 5. GND |
| 6. CATHODE | 6. VCC | 6. CATHODE 1 | 6. COLLECTOR 1 | 6. COLLECTOR 1 | 6. VOUT1 |
| STYLE 19: | STYLE 20: | STYLE 21: | STYLE 22: | STYLE 23: | STYLE 24: |
| PIN 1. I OUT | PIN 1. COLLECTOR | PIN 1. ANODE 1 | PIN 1. D1 (i) | PIN 1. Vn | PIN 1. CATHODE |
| 2. GND | 2. COLLECTOR | 2. N/C | 2. GND | 2. CH1 | 2. ANODE |
| 3. GND | 3. BASE | 3. ANODE 2 | 3. D2 (i) | 3. Vp | 3. CATHODE |
| 4. V CC | 4. EMITTER | 4. CATHODE 2 | 4. D2 (c) | 4. N/C | 4. CATHODE |
| 5. V EN | 5. COLLECTOR | 5. N/C | 5. VBUS | 5. CH2 | 5. CATHODE |
| 6. V REF | 6. COLLECTOR | 6. CATHODE 1 | 6. D1 (c) | 6. N/C | 6. CATHODE |
| STYLE 25: | STYLE 26: | STYLE 27: | STYLE 28: | STYLE 29: | STYLE 30: |
| PIN 1. BASE 1 | PIN 1. SOURCE 1 | PIN 1. BASE 2 | PIN 1. DRAIN | PIN 1. ANODE | PIN 1. SOURCE 1 |
| 2. CATHODE | 2. GATE 1 | 2. BASE 1 | 2. DRAIN | 2. ANODE | 2. DRAIN 2 |
| 3. COLLECTOR 2 | 3. DRAIN 2 | 3. COLLECTOR 1 | 3. GATE | 3. COLLECTOR | 3. DRAIN 2 |
| 4. BASE 2 | 4. SOURCE 2 | 4. EMITTER 1 | 4. SOURCE | 4. EMITTER | 4. SOURCE 2 |
| 5. EMITTER | 5. GATE 2 | 5. EMITTER 2 | 5. DRAIN | 5. BASE/ANODE | 5. GATE 1 |
| 6. COLLECTOR 1 | 6. DRAIN 1 | 6. COLLECTOR 2 | 6. DRAIN | 6. CATHODE | 6. DRAIN 1 |

Note: Please refer to datasheet for style callout. If style type is not called out in the datasheet refer to the device datasheet pinout or pin assignment.

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SOT-563, 6 LEAD CASE 463A ISSUE H

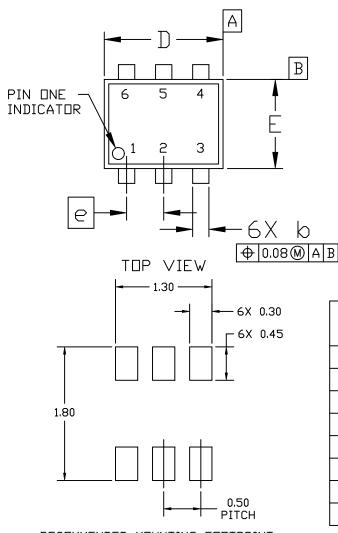
DATE 26 JAN 2021

ALE 4:1

NDTES: 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2009.

А

- 1. DIMENSIONING AND TOLERANCING PER A 2. CONTROLLING DIMENSION: MILLIMETERS
- 3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS DF BASE MATERIAL.



SIDE VIEW MILLIMETERS DIM MIN. NDM. MAX. 0.50 0.55 0.60 Α 0.17 0.22 0.27 b 0.08 0.13 0.18 С 1.50 1.60 1.70 D Ε 1.10 1.20 1.30 0.50 BSC e L 0.10 0.20 0.30 H_E 1.50 1.60 1.70

 $\overline{}$

RECOMMENDED MOUNTING FOOTPRINT* * For additional information on our Pb-Free strategy and soldering details, please download the DN Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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| STYLE 1: | STYLE 2: | STYLE 3: |
|---|---|------------------|
| PIN 1. EMITTER 1 | PIN 1. EMITTER 1 | PIN 1. CATHIDE 1 |
| 2. BASE 1 | 2. EMITTER 2 | 2. CATHIDE 1 |
| 3. COLLECTOR 2 | 3. BASE 2 | 3. ANUDE/ANUDE 2 |
| 4. EMITTER 2 | 4. COLLECTOR 2 | 4. CATHIDE 2 |
| 5. BASE 2 | 5. BASE 1 | 5. CATHIDE 2 |
| 6. COLLECTOR 1 | 6. COLLECTOR 1 | 6. ANUDE/ANUDE 1 |
| STYLE 4: | STYLE 5: | STYLE 6: |
| PIN 1. COLLECTOR | PIN 1. CATHODE | PIN 1. CATHODE |
| 2. COLLECTOR | 2. CATHODE | 2. ANODE |
| 3. BASE | 3. ANODE | 3. CATHODE |
| 4. EMITTER | 4. ANODE | 4. CATHODE |
| 5. COLLECTOR | 5. CATHODE | 5. CATHODE |
| 6. COLLECTOR | 6. CATHODE | 6. CATHODE |
| STYLE 7: | STYLE 8: | STYLE 9: |
| PIN 1. CATHODE | PIN 1. DRAIN | PIN 1. SDURCE 1 |
| 2. ANODE | 2. DRAIN | 2. GATE 1 |
| 3. CATHODE | 3. GATE | 3. DRAIN 2 |
| 4. CATHODE | 4. SDURCE | 4. SDURCE 2 |
| 5. ANODE | 5. DRAIN | 5. GATE 2 |
| 6. CATHODE | 6. DRAIN | 6. DRAIN 1 |
| STYLE 10: PIN 1. CATHODE 1 2. N/C 3. CATHODE 2 4. ANODE 2 5. N/C 6. ANODE 1 | STYLE 11: PIN 1. EMITTER 2 2. BASE 2 3. COLLECTOR 1 4. EMITTER 1 5. BASE 1 6. COLLECTOR 2 | |

6. COLLECTOR 2

DATE 26 JAN 2021

GENERIC **MARKING DIAGRAM***



XX = Specific Device Code

M = Month Code

. = Pb-Free Package

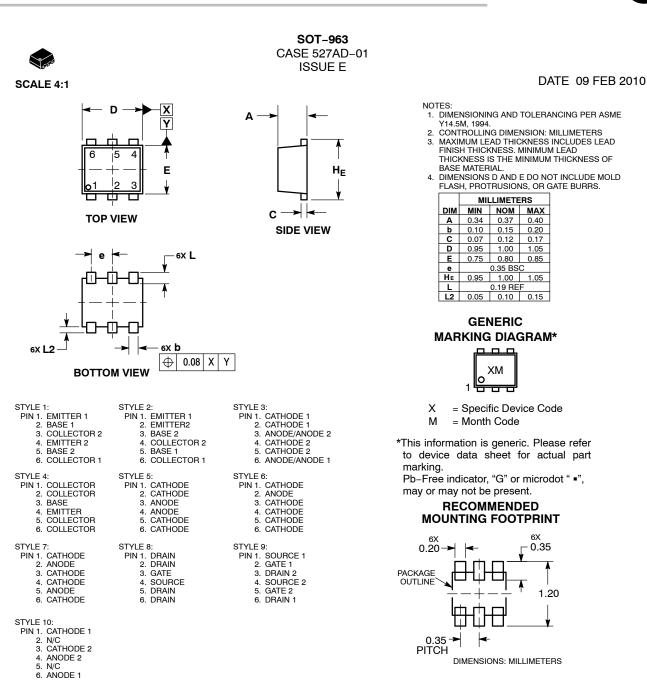
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